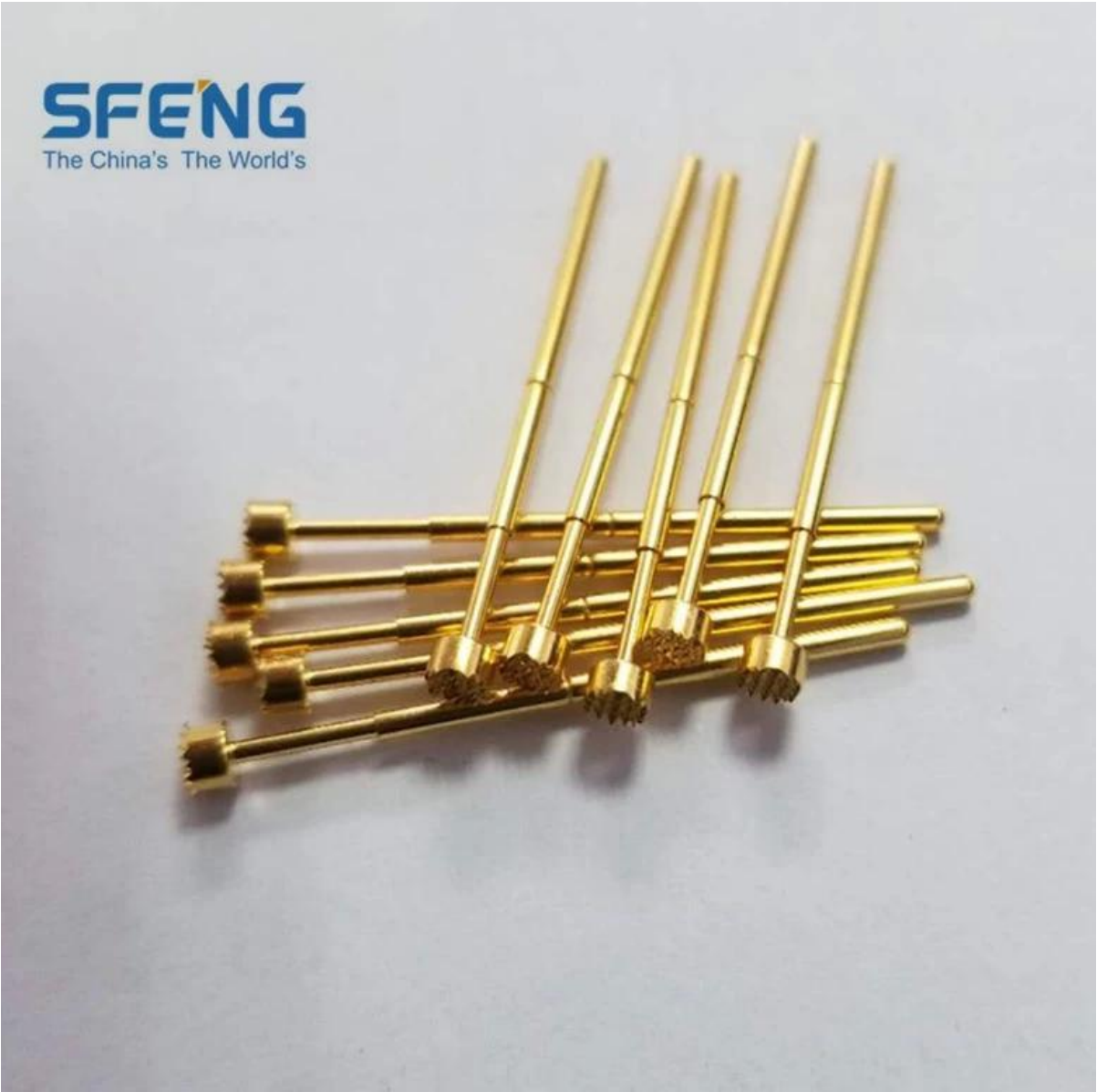


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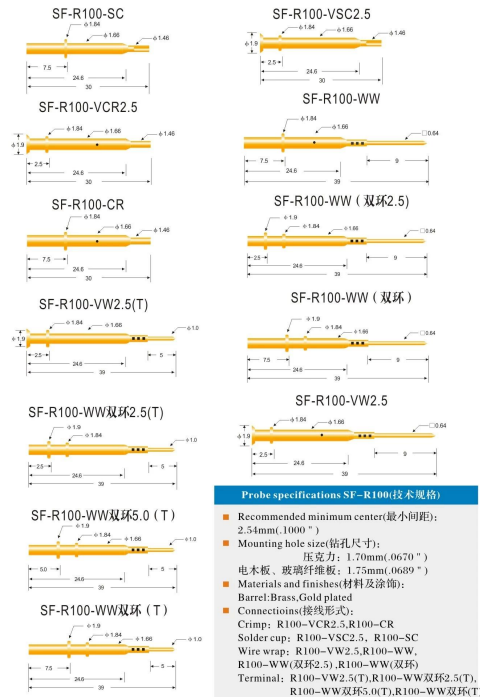
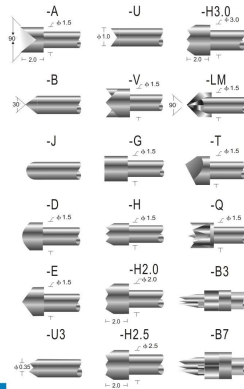




SF-P100-E

Probe specifications SF-P100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(.1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670") 电木板、玻璃纤维板: 1.75mm(.0689")
- Full travel(行程): 6.40(.2520")
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; SK4, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)



Probe specifications SF-R100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(.1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670") 电木板、玻璃纤维板: 1.75mm(.0689")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R100-VCR2.5, R100-CR Solder cup: R100-VSC2.5, R100-SC Wire wrap: R100-VW2.5, R100-WW, R100-WW(双环2.5), R100-WW(双环) Terminal: R100-VW2.5(T), R100-WW双环2.5(T), R100-WW双环5.0(T), R100-WW双环(T)



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2. OEM
- 3.
- 4.



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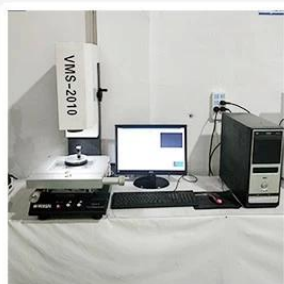
LM QZ VZ

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30 OK POM



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope



Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

